

Product Name: TPM380FWFG

Package Name: LQFP100

### 1.Reflow

Number: 3 times maximum

Peak : 260 deg.C

Reflow zone : 255 deg.C within 30 seconds, 217 deg.C 60 to 150 seconds

Preheat : 150 to 200 deg.C , 60 to 120 seconds

NOTE: All temperatures refer to the package body surface.

The heat-resistant temperature profile is shown in Fig.1.

The temperatures in this profile are the maximum guaranteed temperatures that the device endures.

Select the temperatures for a pre-heat and a heat most suitable for your solder paste type, etc. within the conditions described in Fig.1.

This package is dry-packed in a moisture barrier bag. After opening the bag, keep the devices at or lower than 30deg.C/ 60%RH and complete a final reflow process within 168hours.

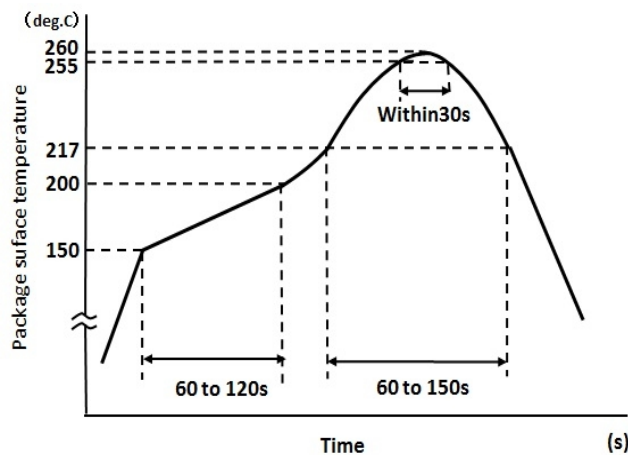


Fig.1 Example of Heat-resistant Temperature Profile

### 2.Others

We urge you to verify well before mounting to assure enough solder joint strength.

Always solder the Product in accordance with the heat-resistance mounting conditions set forth above. In the event the Product is soldered otherwise, the applicable product warranty, if any, is void.

## Moisture Absorption Control Level (Moisture Sensitivity Level)

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Always store the Product under moisture sensitivity level equivalent to level 3 (JEDEC J-STD-020 Moisture Sensitivity Level). In the event the Product is stored otherwise, the applicable warranty, if any, is void.

Always perform reflow soldering in accordance with methods and conditions as specified in applicable engineering documents or specifications provided by Toshiba, or as instructed in writing by your TOSHIBA sales representative.  
In the event the Product is soldered otherwise, the applicable product warranty, if any, is void.

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